# SiHP22N65E

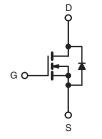
**Vishay Siliconix** 



# **E Series Power MOSFET**

PRODUCT SUMMARY					
V <sub>DS</sub> (V) at T <sub>J</sub> max.	700				
R <sub>DS(on)</sub> max. at 25 °C (Ω)	V <sub>GS</sub> = 10 V 0.18				
Q <sub>g</sub> max. (nC)	110				
Q <sub>gs</sub> (nC)	15				
Q <sub>gd</sub> (nC)	32				
Configuration	Single				

# то-220АВ



N-Channel MOSFET

#### FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (C<sub>iss</sub>)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q<sub>q</sub>)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of

compliance please see <u>www.vishay.com/doc?99912</u>

### Note

\* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non-RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details.

#### APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Renewable energy
  - Solar (PV inverters)

ORDERING INFORMATION				
Package	TO-220AB			
Lead (Pb)-free	SiHP22N65E-E3			
Lead (Pb)-free and Halogen-free	SiHP22N65E-GE3			

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_c = 25 \text{ °C}$ , unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V <sub>DS</sub>	650	V	
Gate-Source Voltage			V <sub>GS</sub>	± 30	V	
Continuous Drain Current (T. 150 °C)	V at 10 V	T <sub>C</sub> = 25 °C T <sub>C</sub> = 100 °C	- I <sub>D</sub>	22		
Continuous Drain Current (T <sub>J</sub> = 150 °C)	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C		14	А	
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	56		
Linear Derating Factor				1.8	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	691	mJ	
Maximum Power Dissipation			P <sub>D</sub>	227	W	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Drain-Source Voltage Slope	be T <sub>J</sub> = 125 °C			70		
Reverse Diode dV/dt <sup>d</sup>			dV/dt	26	V/ns	
Soldering Recommendations (Peak Temperature) c for 10 s				300	°C	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b.  $V_{DD}$  = 50 V, starting T<sub>J</sub> = 25 °C, L = 28.2 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 7 A.

c. 1.6 mm from case.

d.  $I_{SD} \leq I_D$ , dI/dt = 100 A/µs, starting  $T_J$  = 25 °C.

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HALOGEN



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THERMAL RESISTANCE RAT								
PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum Junction-to-Ambient	R <sub>thJA</sub>	- 62			°C/W			
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	- 0.55			0,11			
<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C,	unless otherwi	ise noted)						
PARAMETER	SYMBOL	L.	T CONDIT	IONS	MIN.	TYP.	MAX.	UNI
Static		-			1	ł	ł	ļ
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> :	= 0 V, I <sub>D</sub> = 2	250 µA	650	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C,	I <sub>D</sub> = 1 mA	-	0.74	-	V/°0
Gate-Source Threshold Voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> =	250 µA	2	-	4	V
Octo Course Lockson			$V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA
Gate-Source Leakage	I <sub>GSS</sub>		$V_{GS} = \pm 30$	V	-	-	± 1	μA
Zaus Osta Maltana Dusia Orimont		V <sub>DS</sub> =	= 650 V, V <sub>G</sub>	<sub>S</sub> = 0 V	-	-	1	μA
Zero Gate Voltage Drain Current	IDSS	V <sub>DS</sub> = 520 \	/, V <sub>GS</sub> = 0 \	/, T <sub>J</sub> = 125 °C	-	-	10	
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 V$	I	<sub>D</sub> = 11 A	-	0.15	0.18	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>D</sub>	<sub>S</sub> = 8 V, I <sub>D</sub> :	= 5 A	-	6.7	-	S
Dynamic		·			•	•		•
Input Capacitance	C <sub>iss</sub>		V <sub>GS</sub> = 0 V,		-	2415	-	
Output Capacitance	C <sub>oss</sub>	$V_{DS} = 100 V,$ f = 1 MHz		-	118	-		
Reverse Transfer Capacitance	C <sub>rss</sub>			-	4	-		
Effective Output Capacitance, Energy Related <sup>a</sup>	C <sub>o(er)</sub>	$V_{\rm DS}$ = 0 V to 520 V, $V_{\rm GS}$ = 0 V		-	89	-	pF	
Effective Output Capacitance, Time Related <sup>b</sup>	C <sub>o(tr)</sub>			-	307	-	1	
Total Gate Charge	Qg				-	73	110	1
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V I <sub>D</sub> = 11 A, V <sub>DS</sub> = 520 V		-	15	-	nC	
Gate-Drain Charge	Q <sub>gd</sub>				-	32	-	1
Turn-On Delay Time	t <sub>d(on)</sub>				-	22	45	
Rise Time	t <sub>r</sub>	V <sub>DD</sub> =	= 520 V, I <sub>D</sub>	= 11 A,	-	33	66	- ns
Turn-Off Delay Time	t <sub>d(off)</sub>		= 10 V, R <sub>g</sub> =		-	73	110	
Fall Time	t <sub>f</sub>		1		-	38	76	1
Gate Input Resistance	Rg	f = 1 MHz, open drain		-	0.64	-	Ω	
Drain-Source Body Diode Characterist	cs							
Continuous Source-Drain Diode Current	١ <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	22		
Pulsed Diode Forward Current	I <sub>SM</sub>			-	-	56	A	
Diode Forward Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °0	C, I <sub>S</sub> = 11 A	, V <sub>GS</sub> = 0 V	-	-	1.2	V
Reverse Recovery Time	t <sub>rr</sub>				-	400	-	ns
Reverse Recovery Charge	Q <sub>rr</sub>	T <sub>J</sub> = 25 °C, I <sub>F</sub> = I <sub>S</sub> = 11 A, dl/dt = 100 A/μs, V <sub>R</sub> = 400 V		-	5.9	-	μC	
Reverse Recovery Current	I <sub>RRM</sub>			_	20	_	A	

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .

b. C<sub>oss(tr)</sub> is a fixed capacitance that gives the same charging time as C<sub>oss</sub> while V<sub>DS</sub> is rising from 0 % to 80 % V<sub>DSS</sub>.



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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

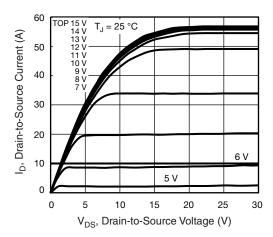


Fig. 1 - Typical Output Characteristics

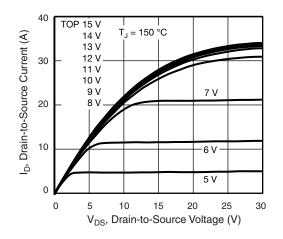


Fig. 2 - Typical Output Characteristics

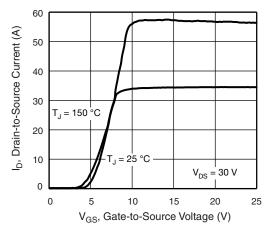


Fig. 3 - Typical Transfer Characteristics

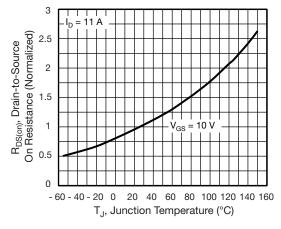


Fig. 4 - Normalized On-Resistance vs. Temperature

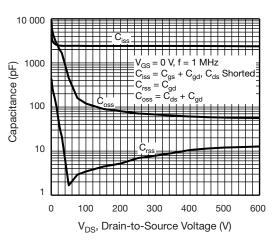


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

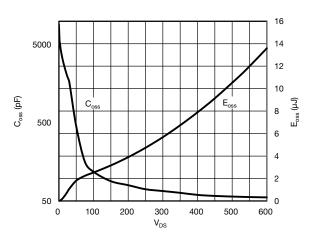


Fig. 6 -  $C_{\rm oss}$  and  $E_{\rm oss}$  vs.  $V_{\rm DS}$ 

S15-0291-Rev B, 23-Feb-15

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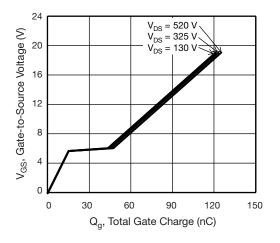


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

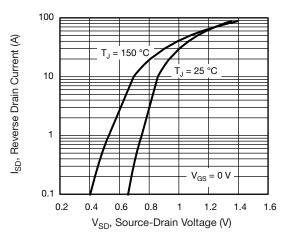


Fig. 8 - Typical Source-Drain Diode Forward Voltage

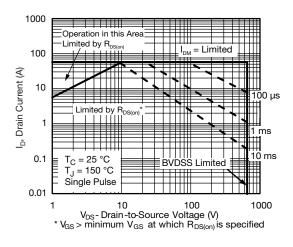


Fig. 9 - Maximum Safe Operating Area

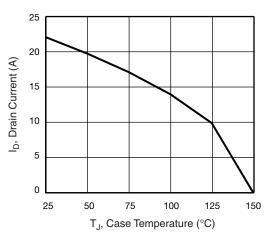


Fig. 10 - Maximum Drain Current vs. Case Temperature

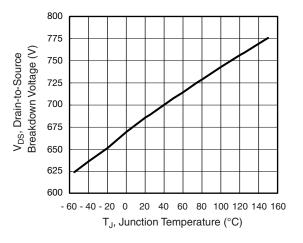
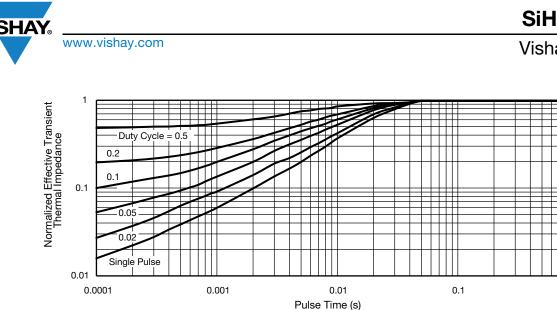
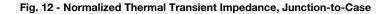


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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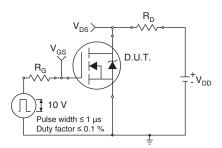


Fig. 13 - Switching Time Test Circuit

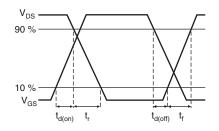


Fig. 14 - Switching Time Waveforms

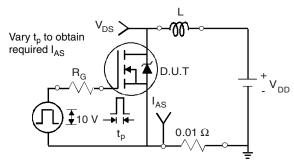


Fig. 15 - Unclamped Inductive Test Circuit

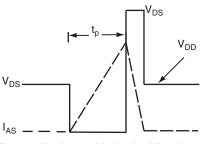


Fig. 16 - Unclamped Inductive Waveforms

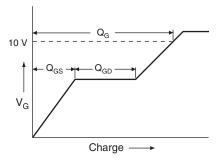


Fig. 17 - Basic Gate Charge Waveform

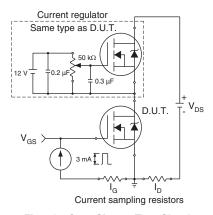


Fig. 18 - Gate Charge Test Circuit

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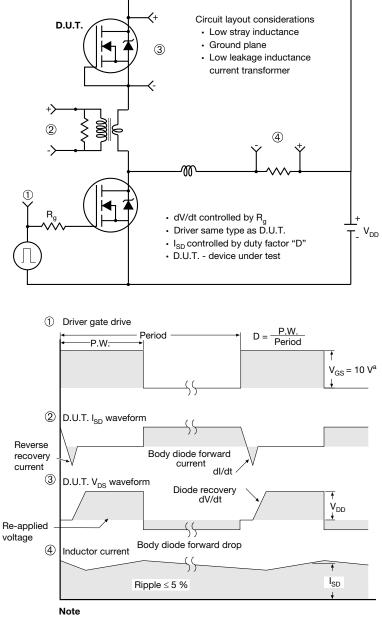
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#### Peak Diode Recovery dV/dt Test Circuit



a.  $V_{GS} = 5 V$  for logic level devices

Fig. 19 - For N-Channel

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TO-220-1



DIM.	MILLIN	IETERS	INCHES		
DIN.	MIN.	MAX.	MIN.	MAX.	
А	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
E	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØР	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	
ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031					

Note

-  $M^{\star}$  = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

Package Picture					
ASE		Xi'an			
		IRF 9510 744K AB			

Revison: 14-Dec-15

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